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/ Ruth Montalvo

Date: 12/22/05

Customer No.

026418

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney's Docket No.:

JG-SU-5223/500577.

U.S. Application No.:

International Application No.:

PCT/JP2005/000882

International Filing Date:

JANUARY 25, 2005

25 JANUARY 2005

Priority Date Claimed:

JANUARY 30, 2004

30 JANUARY 2004

Title of Invention:

SILICON SINGLE CRYSTAL PULLING METHOD

Applicant(s) for (DO/EO/US):

Kazuhiro HARADA, Norihito FUKATSU, Senlin FU and Yoji

SUZUKI

Mail Stop PCT Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-450

INFORMATION DISCLOSURE STATEMENT

SIR:

Applicant herewith submits together with the simultaneously filed National Phase application of PCT/JP2005/000882, a copy of the International Search Report (PCT/ISA/210) dated March 8, 2005, citing some of the following references:

	Document Number	Date	Name and/or Country	English Translation and/or Equivalent
AA	6,045,610	04/04/2000	Park, et al.	
AB	2002/0157600	10/31/2002	Fusegawa, et al.	
AL	11-001393	06/01/1999	Japan	U.S. 6,045,610
AM	60-033291	02/20/1985	Japan	Abstract only
AN	04-031386	02/03/1992	Japan	Abstract only
AO	2001/63027	08/30/2001	WIPO	Abstract only
AP	2002-201092	07/16/2002	Japan	Abstract only
AQ	2003-002783	01/08/2003	Japan	Abstract only
AR	2003-220875	05/08/2003	Japan	Abstract only

Accompanying this Information Disclosure Statement and form PTO-1449 are copies of the documents including English Abstract and US equivalent. Documents AA, AL and AR are mentioned on pages 5 and 8 of the substitute specification.

IAP20 Resid 277 1/70 22 DEC 2005

The USPTO waived the requirement under 37 C.F.R. §1.98(a)(2)(i) for submitting copies of US patents and US patent application publications in all U.S. applications filed after June 30, 2003. First pages of US documents only.

This submission is not an admission that the information disclosed in the documents is material to the patentability of the invention disclosed and/or claimed in the above-identified application.

Respectfully submitted,

JEG:ram 08/10/05

Tel. (212) 521-5400

Enclosures:

Search Report (PCT/ISA/210); PTO-1449

2 first pages of US documents

5 foreign documents

7 English Abstract (including WO document)

Jules E. Goldberg - R Reed Smith LLP

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New York, NY 10022-7650

LIST OF PRIOR ART CITED BY APPLICANT (Filed on December 22, 2005)

JG-SU-5223/500577.

Docket No.

Applicant(s): Application No.		Kazuhiro HARADA, Norihito FUKATSU, Senlin FU and Yoji SUZUKI							
		(Int'l Appln No. PCT/JP2005/000882 25JAN05) Group:							
Filed:				Examiner:					
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			U.S. PATE	NT DOCUMENTS					
Exam.		Document Number	Date	Name	Class	Sub- Class	Filing Date Appropriate		
	AA	6,045,610	04/04/2000	Park, et al.					
_	AB	2002/0157600	10/31/2002	Fusegawa, et al.					
	AC								
	AD								
	AE								
	AF								
	AG								
	AH								
	Al								
	AJ								
	AK								

FOREIGN PATENT DOCUMENTS

	Document		1		Sub-	Translation	
	Number	Date	Country	CLASS	Class	YES NO	
AL	11-001393	06/01/1999	Japan			U.S. 6,045,610	
AM	60-033291	02/20/1985	Japan			Abstract only	
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AR	2003-220875	05/08/2003	Japan			Abstract only	
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OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages

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Examiner:	 · · · · · · · · · · · · · · · · · · ·	·	Date:	
Examinor.				

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.